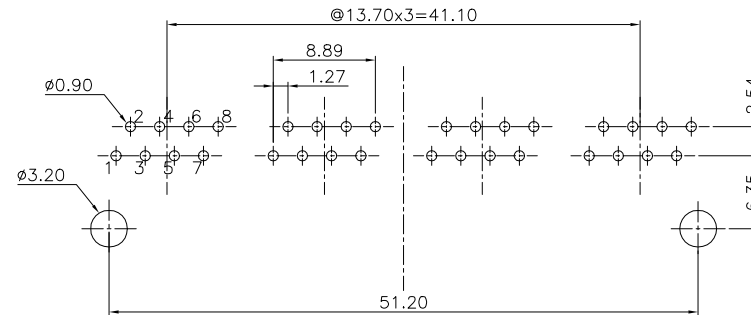
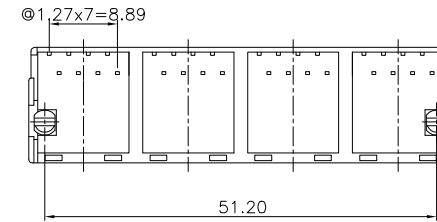
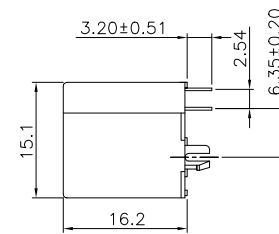
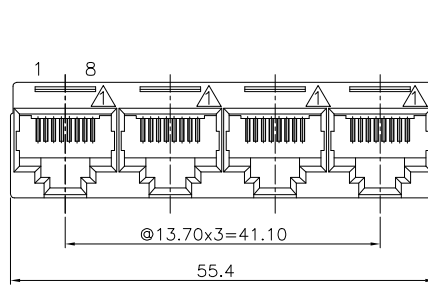


| REVISION RECORD | | | | |
|-----------------|-----|----------------|--------------------|------|
| REV | ECO | DESCRIPTION | DRFT | CHKD |
| △ | | DRAWING MODIFY | Qionpu 4/21/03' | |
| △ | | Add P/N | sammy 08/06/04 | |
| △ | | NOTES MODIFY | Among 10/22/04 | |



PC Board Layout
Component Side Shown

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
- △ 3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
- △ 2. OPERATION: -40°C TO +85°C.

MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.

PART NUMBER: E5288-30C14XXX △

- | | | |
|--------|--------|------------------|
| 1- 3u" | 2- 6u" | FREE - TIN LEAD |
| 3-15u" | 4-30u" | |
| 5-50u" | | -L - LEAD FREE △ |

| | | | | | |
|------------------------|----------------------------|----------------------|--------------------|---|-------|
| DETACHED LISTS | ← MM (INCH) → | DFTO Teng | DATE 7/13/99' | FULL RISE ELECTRONIC CO., LTD | |
| | TOLERANCES EXCEPT AS NOTED | CHKD SAMMY | DATE 2004/11/17 | | |
| | MM | MFO | DATE | TITLE TOP ENTRY GANG JACK W/O SHIELD (4 PORTS) | |
| | .0 ±0.20 | APPVLLUSHENG | DATE 2004/11/17 | | |
| | .00 ±0.15 | MATERIAL : | | DRAWING NO. GE523036 | |
| .000 ±0.075 | ANGLES ± | | /PART NO. SEE NOTE | | |
| THIRD ANGLE PROJECTION | QT'Y : | FINISH : | | SIZE A3 | REV 3 |
| | SCALE : 1.5:1 | DO NOT SCALE DRAWING | | SHEET X | OF Y |